Power Transistors Panasonic

2SD1260, 2SD1260A

Silicon NPN triple diffusion planar type darlington

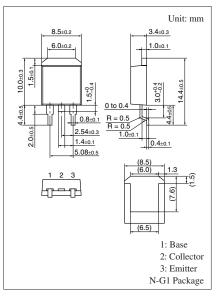
For power amplification
Complementary to 2SB0937, 2SB0937A

■ Features

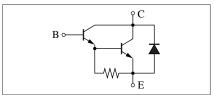
- \bullet High forward current transfer ratio $h_{\!F\!E}$
- High-speed switching
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SD1260	V _{CBO}	60	V
(Emitter open)	2SD1260A		80	
Collector-emitter voltage	2SD1260	V _{CEO}	60	V
(Base open)	2SD1260A		80	
Emitter-base voltage (Col	V_{EBO}	5	V	
Collector current	I_C	2	A	
Peak collector current	I_{CP}	4	A	
Collector power dissipation	P _C	35	W	
	$T_a = 25^{\circ}C$		1.3	
Junction temperature	T_{j}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



Note) Self-supported type package is also prepared. Internal Connection



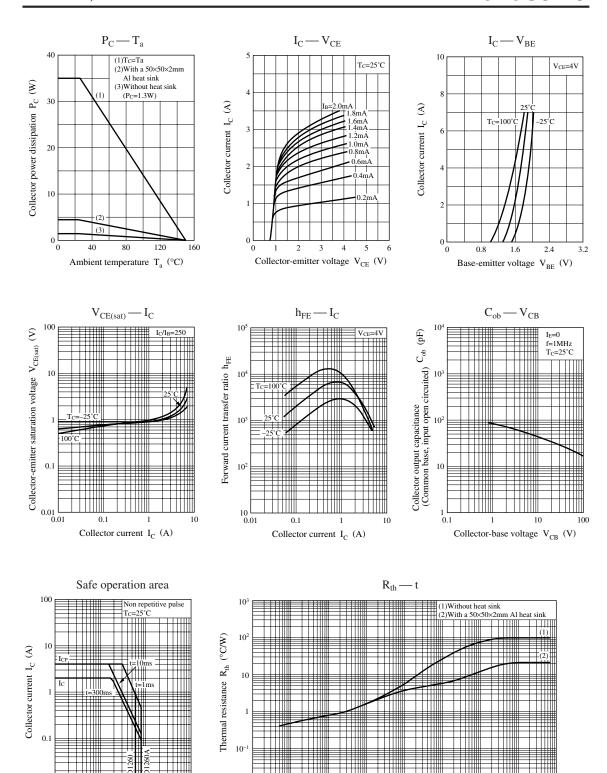
■ Electrical Characteristics $T_C = 25$ °C ± 3 °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1260	V _{CEO}	$I_C = 30 \text{ mA}, I_B = 0$	60			V
(Base open)	2SD1260A			80			
Base-emitter voltage		V_{BE}	$V_{CE} = 4 \text{ V}, I_{C} = 2 \text{ A}$			2.8	V
Collector-base cutoff	2SD1260	I_{CBO}	$V_{CB} = 60 \text{ V}, I_{E} = 0$			1	mA
current (Emitter open)	2SD1260A		$V_{CB} = 80 \text{ V}, I_{E} = 0$			1	
Collector-emitter cutoff	2SD1260	I_{CEO}	$V_{CE} = 30 \text{ V}, I_{B} = 0$			2	mA
current (Base open)	2SD1260A		$V_{CE} = 40 \text{ V}, I_{B} = 0$			2	
Emitter-base cutoff current (Collector open)		I_{EBO}	$V_{EB} = 5 \text{ V}, I_{C} = 0$			2	mA
Forward current transfer ratio		h _{FE1}	$V_{CE} = 4 \text{ V}, I_{C} = 1 \text{ A}$	1000			_
		h _{FE2} *	$V_{CE} = 4 \text{ V}, I_{C} = 2 \text{ A}$	1000		10 000	
Collector-emitter saturation voltage		V _{CE(sat)}	$I_C = 2 \text{ A}, I_B = 8 \text{ mA}$			2.5	V
Transition frequency		f_T	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Turn-on time		t _{on}	$I_C = 2 A$		0.5		μs
Strage time		t _{stg}	$I_{B1} = 8 \text{ mA}, I_{B2} = -8 \text{ mA}$		4.0		μs
Fall time		$t_{\rm f}$	$V_{CC} = 50 \text{ V}$		1.0		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	R	Q	Р
h _{FE2}	1000 to 2500	2000 to 5000	4000 to 10000



2 SJD00176BED

1000

100

Collector-emitter voltage V_{CE} (V)

 10^{-2}

10-4

 10^{-3}

 10^{-2}

 10^{-1}

Time t (s)

 10^{2}

 10^{3}

 10^{4}

0.01

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